# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

#### **CONVEYING PARTY DATA**

Name	Execution Date
Shohei TAGAMI	03/01/2010
Takanobu TAKEDA	03/01/2010
Michihiro SUGO	03/01/2010
Hideto KATO	03/01/2010

#### **RECEIVING PARTY DATA**

Name:	Shin-Etsu Chemical Co., Ltd.		
Street Address:	6-1, Otemachi 2-chome, Chiyoda-ku		
City:	Tokyo		
State/Country:	JAPAN		

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12722068

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	0171-1553PUS1	
NAME OF SUBMITTER:	Gerald M. Murphy, Jr.	

Total Attachments: 2

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**REEL: 024742 FRAME: 0140** 

# BIRCH, STEWART, KOLASCH & BIRCH, LLP

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ATTORNEY DOCKET NO. 0171-1553PUS1

### ASSIGNMENT

		Application No. $\underline{1}$	2/722,068	Filed 3/11/2010		
Insert Name(s)		WHEREAS, Shohei TAGAMI, Takanobu TAKEDA, Michihiro SUGO and				
of Inventor(s)		Hideto KA	TO of Annaka-shi, Gunma-k	en, Japan,		
		Joetsu-sh	i, Niigata-ken, Japan, Ar	naka-shi, Gunma-ken, Japan and		
		Annaka-sh	i, Gunma-ken, Japan			
Insert Title of Invention				sted certain new and useful improvements insitive Resin Composition Containing		
		the Novel	Polyimide Silicone, and	Method for Pattern Formation		
			ion for Letters Patent of the United Sta provisional application).	tes of America has been executed by the undersigned		
Insert Date of Signing of Application	<b>165</b>	on	March 1, 2010	; and		
Insert Name of Assignee	<b>***</b>	WHEREAS,_	Shin-Etsu Chemical Co.,	Ltd.		
Insert Address of Assignee	-	of	6-1, Otemachi 2-chome, C	hiyoda-ku, Tokyo, Japan		
CHECK BOX f appropriate	iam)-	acquiring the entire	right, title and interest in and to said efor in the United States of America	reinafter designated as the Assignee) is desirous of invention and in and to any Letters Patent(s) that and		
		paid, the receipt of whas (have) sold, ass Assignee the full and dependencies and p which may be grante	hich is hereby acknowledged, and othe igned and transferred, and by these d exclusive right to the said inventic ossessions and the entire right, title a	Tren Dollars (\$10.00) to the undersigned in hand r good and valuable consideration, the undersigned presents does sell, assign and transfer unto said in the United States of America, its territories, and interest in and to any and all Letters Patent(s) erica, its territories, dependencies and possessions, countries;		

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or

terms for which the same may be granted.

PATENT REEL: 024742 FRAME: 0141 The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date March 1, 2010	Name of Inventor		Shoulaei	Tagami	
		(signature)	_	Shohei TAGAMI	
Date March 1, 2010	Name of Inventor		Faborolu	Fakoda	
		(signature)		Takanobu TAKEDA	
Date March 1, 2010	Name of Inventor		mat	hm	
		(signature)		Michihiro SUGO	
Date March 1, 2010	Name of Inventor		dideto	Rato	
		(signature)		Hideto KATO	
Date,	Name of Inventor				
		(signature)			
Date,	Name of Inventor				
		(signature)			

RECORDED: 07/26/2010

PATENT REEL: 024742 FRAME: 0142